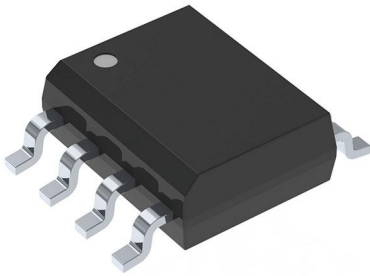


# IPS7091GPBF Datasheet

[www.digi-electronics.com](http://www.digi-electronics.com)



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	IPS7091GPBF-DG
Manufacturer	<a href="#">Infineon Technologies</a>
Manufacturer Product Number	IPS7091GPBF
Description	IC SWITCH IPS HIGH SIDE 8-SOIC
Detailed Description	Power Switch/Driver 1.5A 8-SOIC



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

DiGi is a global authorized distributor of electronic components.

## Purchase and inquiry

Manufacturer Product Number:

IPS7091GPBF

Series:

-

Number of Outputs:

1

Voltage - Load:

6V ~ 35V

Rds On (Typ):

80mOhm

Operating Temperature:

-40°C ~ 150°C

Supplier Device Package:

8-SOIC

Base Product Number:

IPS7091

Manufacturer:

Infineon Technologies

Product Status:

Obsolete

Output Configuration:

High Side

Current - Output (Max):

1.5A

Input Type:

Non-Inverting

Mounting Type:

Surface Mount

Package / Case:

8-SOIC (0.154", 3.90mm Width)

## Environmental & Export classification

Moisture Sensitivity Level (MSL):

2 (1 Year)

ECCN:

EAR99

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

## IPS7091(G)(S)PbF

### INTELLIGENT POWER HIGH SIDE SWITCH

#### Features

- Over temperature shutdown (with auto-restart)
- Short circuit protection (current limit)
- Active clamp
- Open load detection
- Logic ground isolated from power ground
- ESD protection
- Ground loss protection
- Status feedback

#### Product Summary

$R_{ds(on)}$	120m $\Omega$ max.
$V_{clamp}$	70V
I Limit	5A (typ.)
Open load	3V

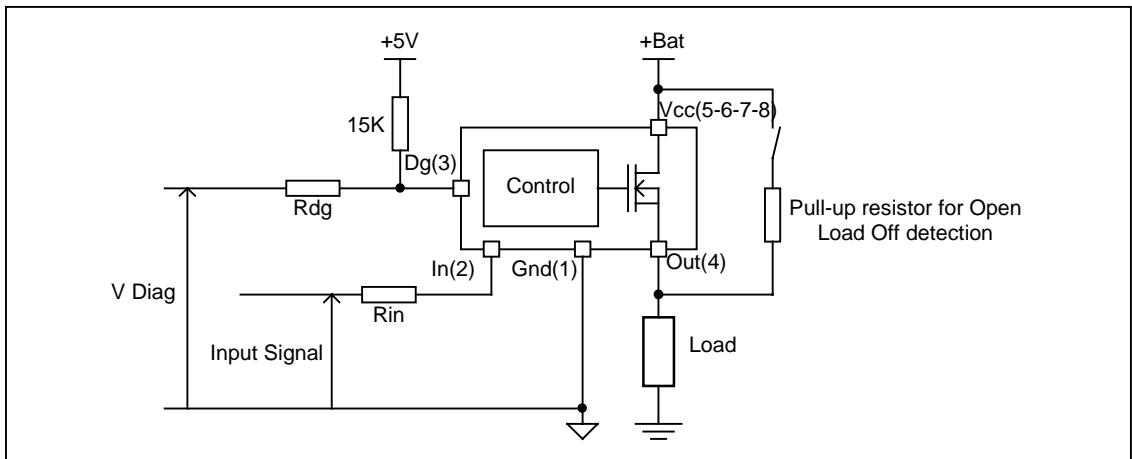
#### Description

The IPS7091(G)(S)PbF is a five terminal Intelligent Power Switch (IPS) with built in short circuit, over-temperature, ESD protection, inductive load capability and diagnostic feedback. The output current is limited at  $I_{lim}$  value. Current limitation is activated until the thermal protection acts. The over-temperature protection turns off the device if the junction temperature exceeds  $T_{shutdown}$ . It will automatically restart after the junction has cooled 7°C below  $T_{shutdown}$ . A diagnostic pin is provided for status feedback of short circuit, over-temperature and open load detection. The double level shifter circuitry allows large offsets between the logic ground and the load.

#### Package



#### Typical Connection



## Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are referenced to Ground lead. (Tamb=25°C unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
Vout	Maximum output voltage	Vcc-65	Vcc+0.3	V
Voffset	Maximum logic ground to load ground offset	Vcc-65	Vcc+0.3	
Vin	Maximum input voltage	-0.3	5.5	
Vcc max.	Maximum Vcc voltage	—	65	
Vcc cont.	Maximum continuous Vcc voltage	—	35	
Iin max.	Maximum IN current	-1	10	mA
I <sub>dg</sub> max.	Maximum diagnostic output current	-1	10	
V <sub>dg</sub>	Maximum diagnostic output voltage	-0.3	5.5	V
P <sub>d</sub>	Maximum power dissipation (internally limited by thermal protection) R <sub>th</sub> =100°C/W	—	1.25	W
I <sub>sd</sub> cont.	Maximum continuous diode current (R <sub>th</sub> =100°C/W)	—	1.8	A
ESD1	Electrostatic discharge voltage (Human body) 100pF, 1500Ω	—	4	kV
ESD2	Electrostatic discharge voltage (Machine Model) C=200pF, R=0Ω, L=10μH	—	0.5	
T <sub>j</sub> max.	Max. storage & operating temperature junction temperature	-40	+150	°C

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
R <sub>th1</sub>	Thermal resistance junction to ambient SO8 std. footprint	100	—	°C/W
R <sub>th1</sub>	Thermal resistance junction to ambient TO220 free air	60	—	
R <sub>th1</sub>	Thermal resistance junction to ambient D2Pak std. footprint	60	—	
R <sub>th2</sub>	Thermal resistance junction to ambient D2Pak 1" sqrt. footprint	40	—	
R <sub>th3</sub>	Thermal resistance junction to case D2pak/TO220	4	—	

## Recommended Operating Conditions

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
V <sub>IH</sub>	High level input voltage	4	5.5	
V <sub>IL</sub>	Low level input voltage	-0.3	0.9	
I <sub>out</sub>	Continuous drain current, Tamb=85°C, T <sub>j</sub> =125°C, V <sub>in</sub> =5V, R <sub>th</sub> =100°C/W	—	1.5	A
R <sub>in</sub>	Recommended resistor in series with IN pin	10	20	kΩ
R <sub>dg</sub>	Recommended resistor in series with DG pin	10	20	
R <sub>ol</sub>	Recommended pull-up resistor for open load detection	5	100	



**Static Electrical Characteristics**

T<sub>J</sub>=25°C, V<sub>CC</sub>=14V (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
R <sub>ds(on)</sub>	ON state resistance T <sub>J</sub> =25°C	—	80	120	mΩ	V <sub>in</sub> =5V, I <sub>out</sub> =2A
	ON state resistance T <sub>J</sub> =150°C	—	150	230		V <sub>in</sub> =5V, I <sub>out</sub> =2A
	ON state resistance T <sub>J</sub> =25°C, V <sub>CC</sub> =6.5V	—	90	130		V <sub>in</sub> =5V, I <sub>out</sub> =2A
V <sub>CC op.</sub>	Operating voltage range	6	—	35	V	
V clamp 1	V <sub>CC</sub> to Out clamp voltage 1	65	70	—		I <sub>out</sub> =30mA (see Fig. 1)
V clamp 2	V <sub>CC</sub> to Out clamp voltage 2	—	70	75		I <sub>out</sub> =1A (see Fig. 1)
V <sub>f</sub>	Body diode forward voltage	—	1	1.35		I <sub>out</sub> = 2.5A
I <sub>CC Off</sub>	Supply current when Off	—	2.5	10	μA	V <sub>in</sub> =0V, V <sub>out</sub> =0V
I <sub>CC On</sub>	Supply current when On	—	2.5	3.5	mA	V <sub>in</sub> =5V
I <sub>out@0V</sub>	Output leakage current	—	—	10	μA	V <sub>out</sub> =0V
I <sub>out@6V</sub>	Output leakage current	—	20	—		V <sub>out</sub> =6V
I <sub>dg leakage</sub>	Diagnostic output leakage current	—	—	10		V <sub>dg</sub> =5.5V
V <sub>dgl</sub>	Low level diagnostic output voltage	—	0.2	0.3	V	I <sub>dg</sub> =1.6mA
V <sub>ih</sub>	Input high threshold voltage	—	2.5	3.5		
V <sub>il</sub>	Input low threshold voltage	1	2	—		
I <sub>n hys</sub>	Input hysteresis	0.15	0.4	1		
UV high	Under voltage high threshold voltage	—	5	5.9		
UV low	Under voltage low threshold voltage	3.4	4.5	—		
UV hys	Undervoltage hysteresis	0.1	0.8	1.5		
I <sub>in On</sub>	Input current when device is On	—	40	80		μA

**Switching Electrical Characteristics**

V<sub>CC</sub>=14V, Resistive load=14Ω, V<sub>in</sub>=5V, T<sub>J</sub>=25°C

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
T <sub>don</sub>	Turn-on delay time	—	12	35	μs	See Fig. 3
Tr1	Rise time to V <sub>out</sub> =V <sub>CC</sub> -5V	—	7	40		
Tr2	Rise time to V <sub>out</sub> =0.9 x V <sub>CC</sub>	—	14	50		
dV/dt (On)	Turn On dV/dt	—	0.95	3.5	V/μs	
E <sub>On</sub>	Turn On energy	—	250	—	μJ	
T <sub>doff</sub>	Turn-off delay time	—	20	45	μs	
T <sub>f</sub>	Fall time to V <sub>out</sub> =0.1 x V <sub>CC</sub>	—	6	25	μs	
dV/dt (Off)	Turn Off dV/dt	—	1.8	5.5	V/μs	
E <sub>Off</sub>	Turn Off energy	—	20	—	μJ	
T <sub>diag</sub>	V <sub>out</sub> to V <sub>diag</sub> propagation delay	—	15	—	μs	See Fig. 4 and Fig. 12

## Protection Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Ilim	Internal current limit	2	5	8	A	Vout=0V
Tsd+	Over temperature high threshold	150 <sup>(1)</sup>	165	—	°C	See Fig. 2
Tsd-	Over temperature low threshold	—	158	—		
Vsc	Short-circuit detection voltage <sup>(2)</sup>	2	3	4	V	
Vopen load	Open load detection threshold	2	3	4		

<sup>(1)</sup> Guaranteed by design

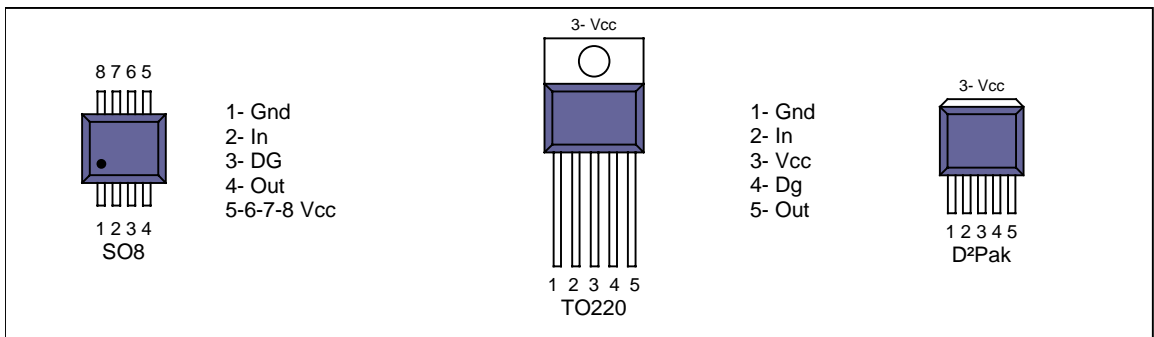
<sup>(2)</sup> Reference to Vcc

## Truth Table

Operating Conditions	IN	OUT	DG pin
Normal	H	H	H
Normal	L	L	L
Open Load	H	H	H
Open Load <sup>(3)</sup>	L	H	H
Short circuit to Gnd	H	L (limiting)	L
Short circuit to Gnd	L	L	L
Over-temperature	H	L (cycling)	L
Over-temperature	L	L	L

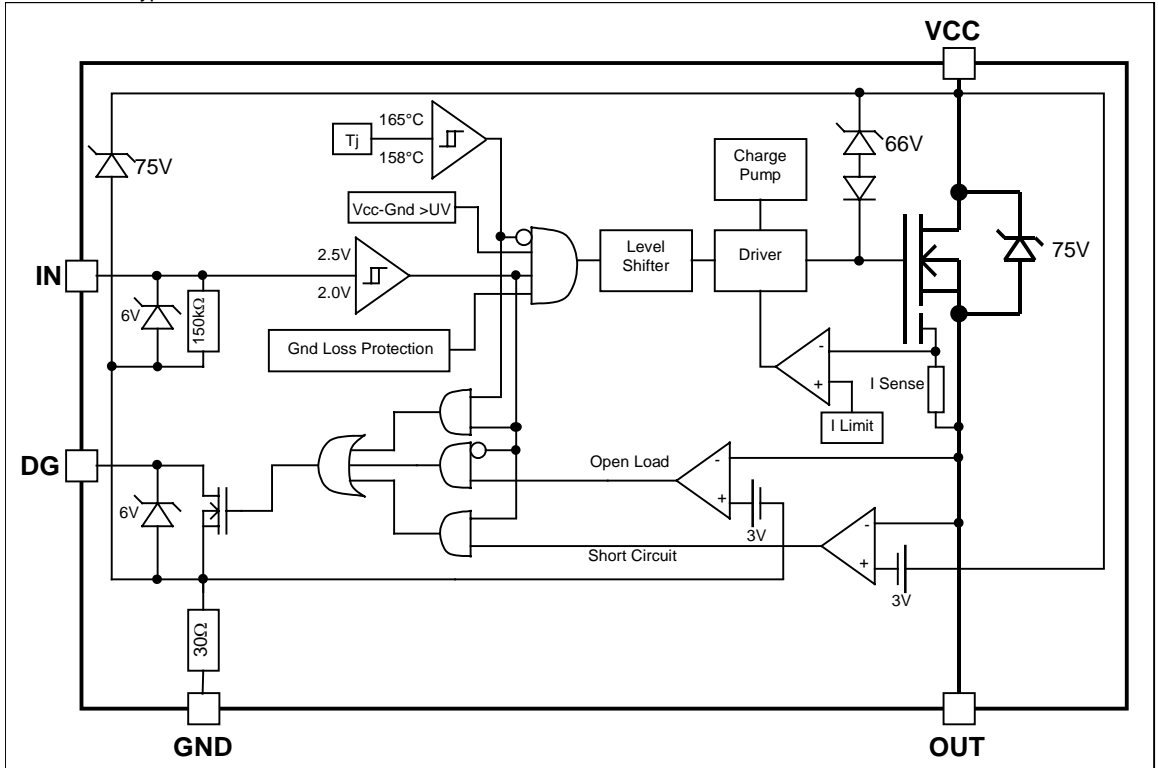
<sup>(3)</sup> With a pull-up resistor connected between the output and Vcc.

## Lead Assignments



## Functional Block Diagram

All values are typical



# IPS7091(G)(S)PbF

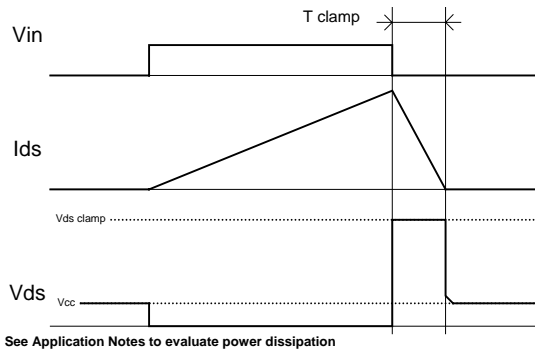


Figure 1 – Active clamp waveforms

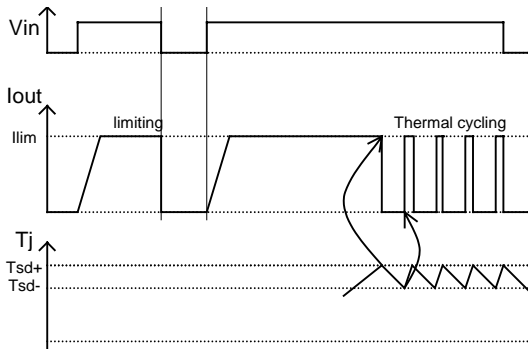


Figure 2 – Protection timing diagram

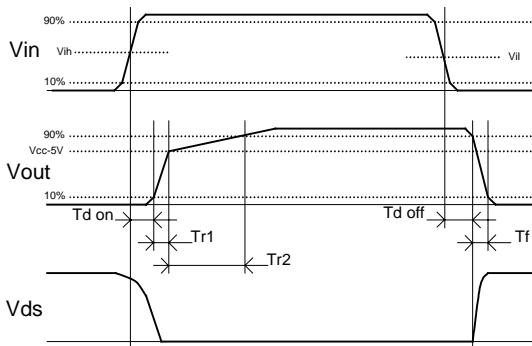


Figure 3 – Switching times definition

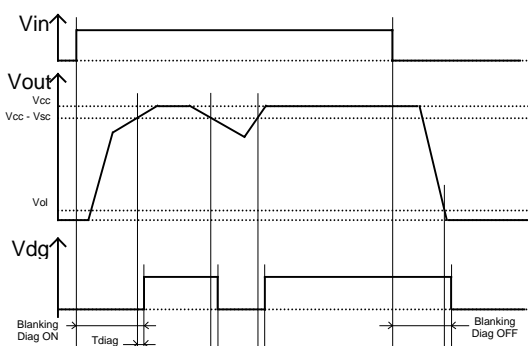
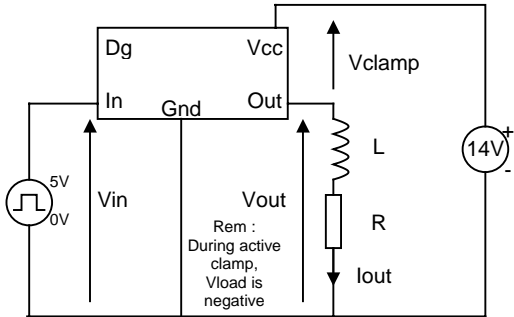
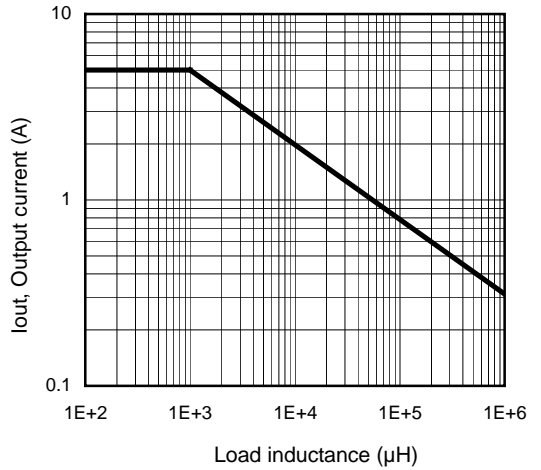


Figure 4 – Diagnostic delay definition

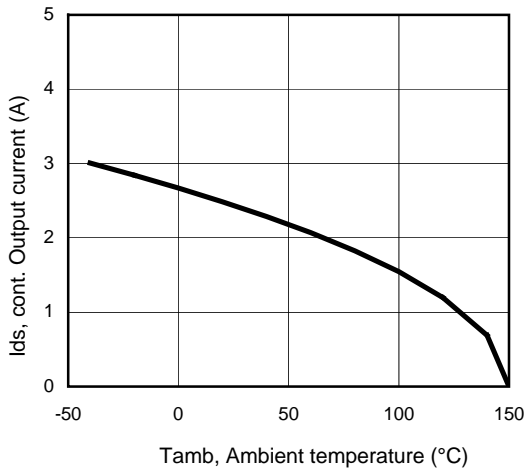




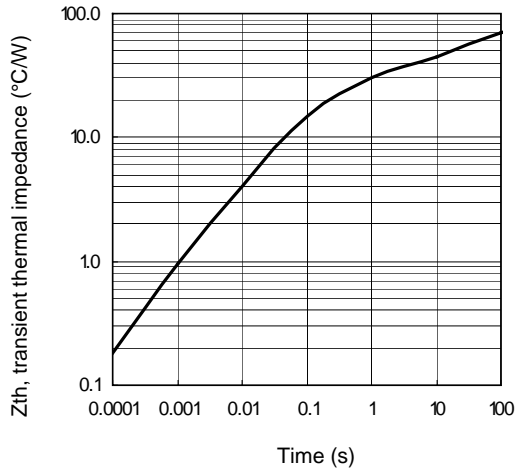
**Figure 5 – Active clamp test circuit**



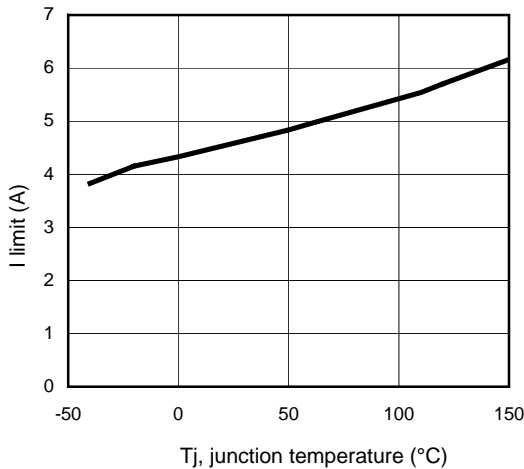
**Figure 6 – Max. Output current (A) Vs Load inductance (µH)**



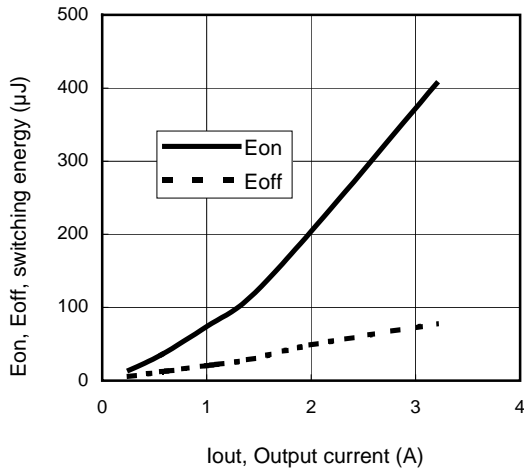
**Figure 7 – Max. output current (A) Vs Ambient temperature (°C) Rth=100°C/W**



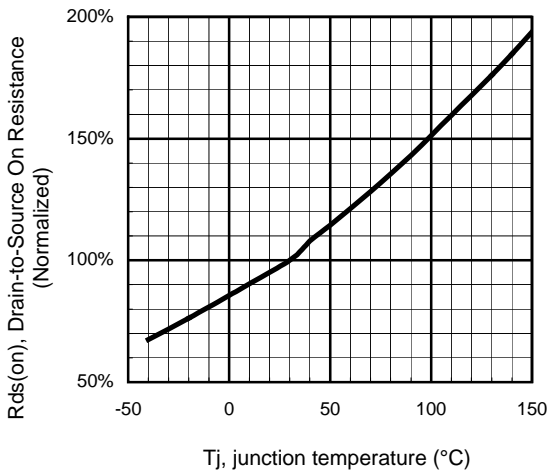
**Figure 8 – Transient thermal impedance (°C/W) Vs time (s)**



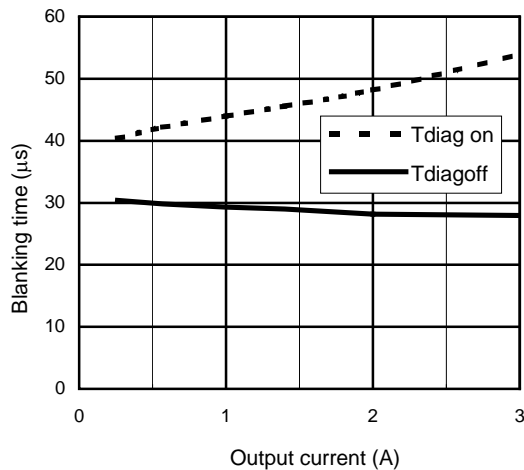
**Figure 9 – I limit (A)  
 Vs junction temperature (°C)**



**Figure 10 – Switching energy (µJ)  
 Vs Output current (A)**



**Figure 11 - Normalized R<sub>ds(on)</sub> (%) Vs T<sub>j</sub> (°C)**



**Figure 12 – Diagnosis Blanking time (µs)  
 Vs Output current (A)**

# IPS7091(G)(S)PbF

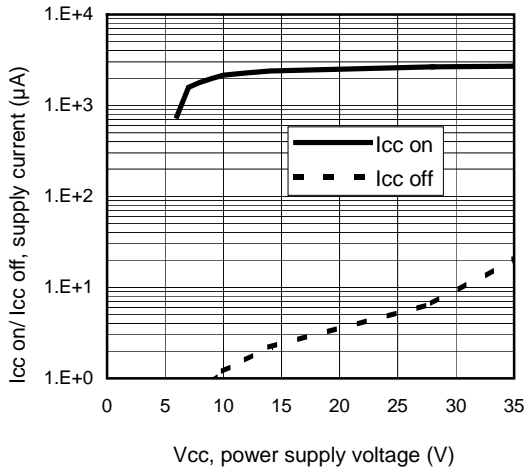


Figure 13 – Icc on/ Icc off (µA) Vs Vcc (V)

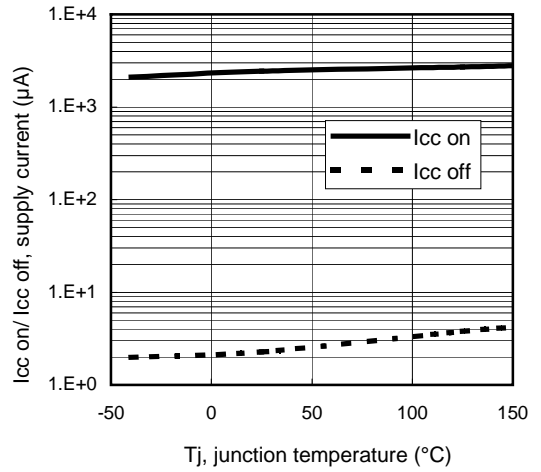
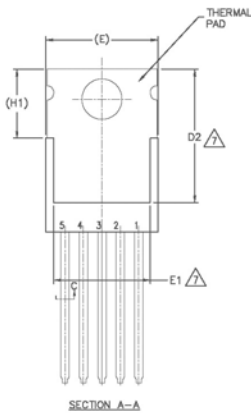
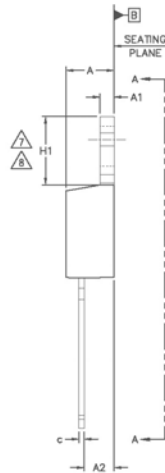
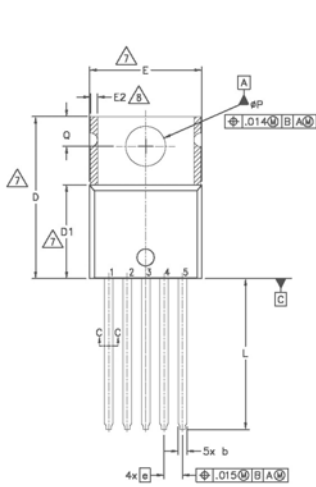


Figure 14 – Icc on/ Icc off (µA) Vs Tj (°C)

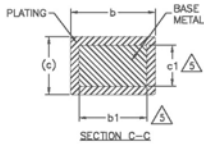
## Case outline - TO220



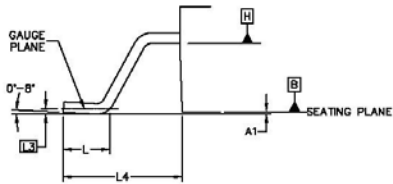
DIMENSIONS	DIMENSIONS				UNIT	
	MILLIMETERS		INCHES			
	MIN.	MAX.	MIN.	MAX.		
A	3.56	4.83	.140	.190	5	
A1	0.51	1.40	.020	.055		
A2	2.03	2.92	.080	.115		
b	0.84	0.89	.025	.035		
b1	0.64	0.84	.025	.033		
c	0.36	0.61	.014	.024		
c1	0.36	0.56	.014	.022		5
D	14.22	16.51	.560	.650		4
D1	8.38	9.02	.330	.355		7
D2	11.68	12.88	.460	.507		
E	9.65	10.67	.380	.420	4,7	
E1	6.86	8.89	.270	.350	7	
E2	-	0.76	-	.030	8	
e	1.70 BSC		.067 BSC		7,8	
H1	5.84	6.86	.230	.270		
L	12.70	14.73	.500	.580		
pP	3.53	3.73	.139	.147		
Q	2.54	3.05	.100	.120		

NOTES:

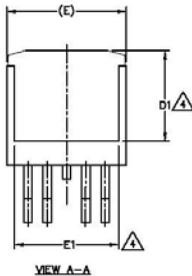
- 1.- DIMENSIONING AND TOLERANCING AS PER ASME Y14.5 M- 1994.
- 2.- DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS].
- 3.- LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.
- 4.- DIMENSION D, D1 & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 5.- DIMENSION b1 & c1 APPLY TO BASE METAL ONLY.
- 6.- CONTROLLING DIMENSION - INCHES.
- 7.- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,H1,D2 & E1
- 8.- DIMENSION E2 X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED.
- 9.- OUTLINE CONFORMS TO JEDEC TO-220, EXCEPT A2 (max.) AND D2 (min.) WHERE DIMENSIONS ARE DERIVED FROM THE ACTUAL PACKAGE OUTLINE.
- 10.- LEADS AND DRAIN ARE PLATED WITH 100% Sn



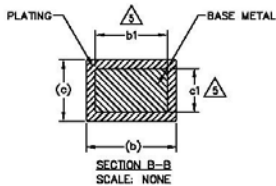
Case outline – D<sup>2</sup>Pak



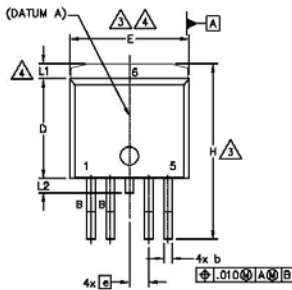
DETAIL "A"  
ROTATED 90° CW  
SCALE: B:1



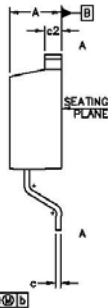
VIEW A-A



SECTION B-B  
SCALE: NONE



DETAIL A

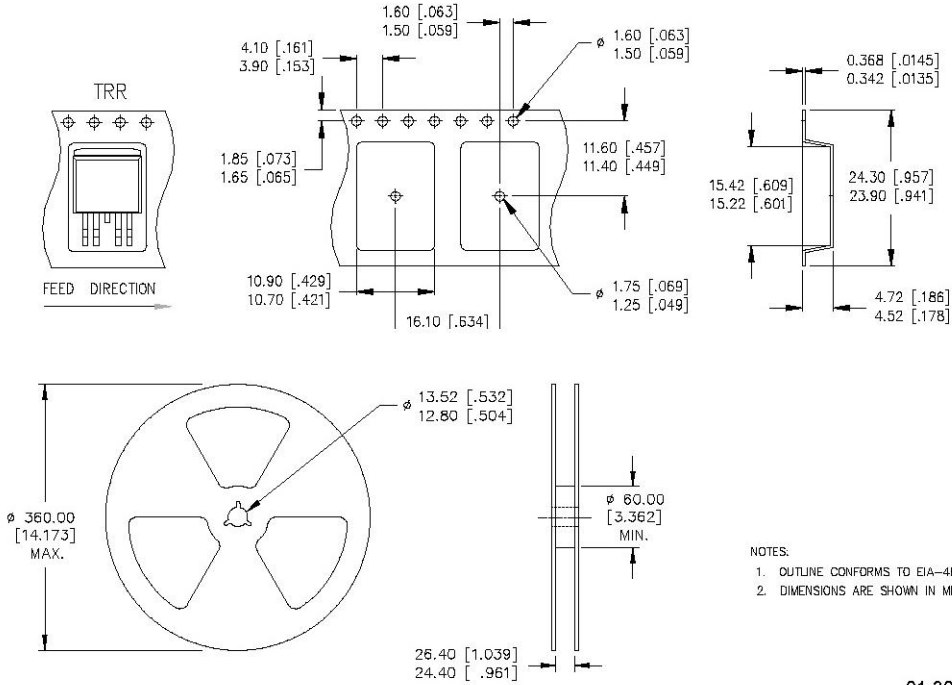


NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [0.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
5. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
7. CONTROLLING DIMENSION: INCH.
8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263BA.
9. LEADS AND DRAIN ARE PLATED : 100% Sn

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.08	4.83	.160	.190	
A1	—	0.254	—	.010	
b	0.51	0.99	.020	.039	4
b1	0.51	0.89	.020	.035	
c	0.38	0.74	.015	.029	
e1	0.38	0.58	.015	.023	4
e2	1.14	1.65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	8.86	—	.270	—	
E	9.65	10.87	.380	.420	3
E1	6.22	—	.245	—	
e	1.70 BSC	—	.067 BSC	—	
H	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1	—	1.68	—	.066	
L2	—	1.78	—	.070	
L3	0.25 BSC	—	.010 BSC	—	
L4	4.78	5.28	.188	.208	

**Tape and reel – D<sup>2</sup>Pak**



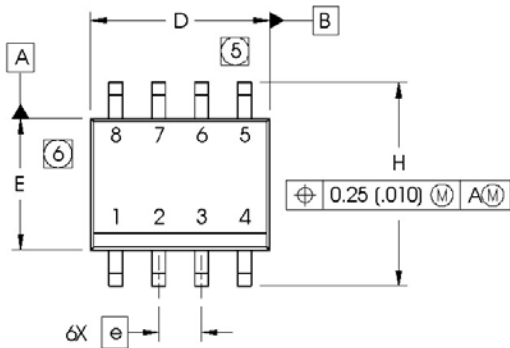
- NOTES:
1. OUTLINE CONFORMS TO EIA-481 & EIA-541.
  2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

01-3071 00 / 01-3072 00

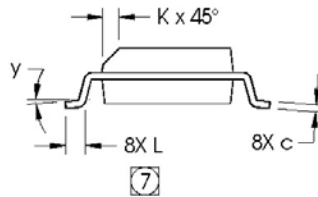
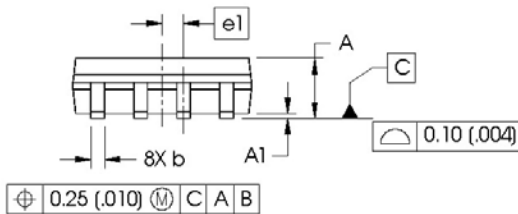


## Case Outline - SO-8

Dimensions are shown in millimeters (inches)

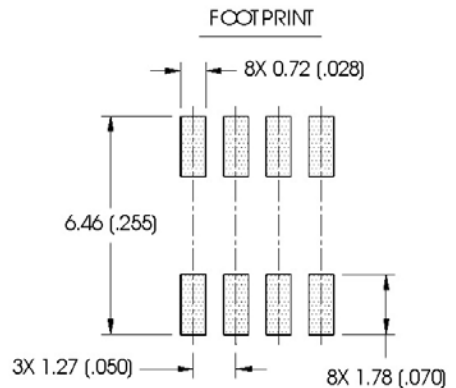


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050 BASIC		1.27 BASIC	
e1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°



**NOTES:**

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- 5 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- 6 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- 7 DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.





**REVISION HISTORY**  
**IPS7091G**

Revision No.	Date	PD No. & Rev. Letter	Page No.	Description	Reason of Change
1		60291_B	all	Add new package version : TO220 / D2pak	
2	09/09/08	60291_C	7	Add Rth=100°C/W figure 7	Information missing

## OUR CERTIFICATE

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